

SCT3040KLHRC11-VB Datasheet N-Channel 1200 V (D-S) SiC Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	1200			
R _{DS(on)} at 25 °C (Ω)	$V_{GS} = 18V$	0.040		
Q _g (nC)	101			

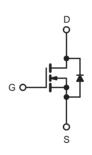
FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_a)
- Avalanche energy rated (UIS)

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- DC/DC converter





N-Channel MOSFET

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	1200	.,	
Gate-Source Voltage			V _{GS}	-10 / +22	V	
Continuous Proin Current (T = 150 °C)	\/ at 19\/	T _C = 25 °C		60		
Continuous Drain Current (T _J = 150 °C)	V_{GS} at 18V $T_C = 100 ^{\circ}C$	I _D	42	Α		
Pulsed Drain Current ^a			I _{DM}	160		
Linear Derating Factor				2.1	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	1200	mJ	
Maximum Power Dissipation			P _D	320	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C	
Drain-Source Voltage Slope	T _J = 1	25 °C		50	1//20	
Reverse Diode dV/dt d			dV/dt	15	V/ns	
Soldering Recommendations (Peak Temperature)	for 10 s			260	°C	

- a. Repetitive rating; pulse width limited by maximum junction temperature. b. $V_{DD}=100$ V, starting $T_{J}=25$ °C, L = 30mH, $R_{g}=25$ Ω , $I_{AS}=9$ A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.



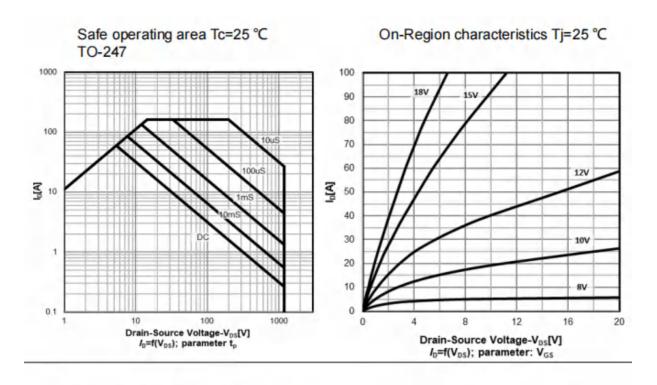
THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	40	°C/W		
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.47	C/VV		

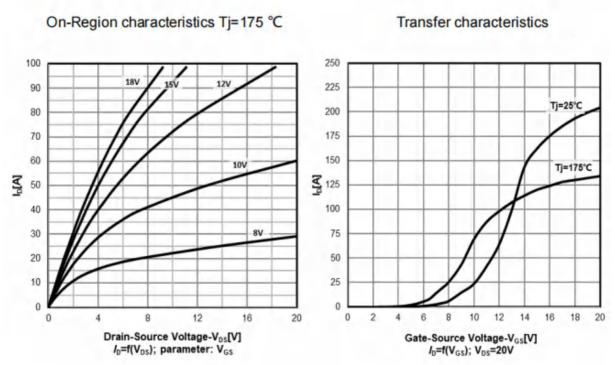
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 1 mA	1200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.70	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}$, $I_D = 10 \text{ mA}$		-	4.5	V
	_	V _{GS} = +22 V		-	-	100	nA
Gate-Source Leakage	I_{GSS}	,	V _{GS} = -10 V		-	100	μΑ
		V _{DS} =	= 1200 V, V _{GS} = 0 V	-	10	_	
Zero Gate Voltage Drain Current	I_{DSS}		V, V _{GS} = 0 V, T _J = 125 °C	-	-	100	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 18 V	I _D = 30A	-	0.040	-	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 0 V, I _D = 30 A	-	16	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 \text{ V},$ $V_{DS} = 800 \text{ V},$ f = 1 MHz		2200	-	pF
Output Capacitance	Coss	1			123	-	
Reverse Transfer Capacitance	C _{rss}				10	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 800 V, V _{GS} = 0 V		-	156	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	268	-	
Total Gate Charge	Qg		V _{GS} = -5/18 V I _D = 20 A, V _{DS} = 800 V		101	-	nC
Gate-Source Charge	Q _{gs}	V _{GS} = -5/18 V			29	-	
Gate-Drain Charge	Q _{gd}			-	33	-]
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 800 \text{ V}, I_{D} = 20\text{A},$ $V_{GS} = -5/18 \text{ V}, R_{g} = 2 \Omega$		ı	18	25	
Rise Time	t _r			ı	24	55	ns
Turn-Off Delay Time	t _{d(off)}			ı	80	-	
Fall Time	t _f			ı	12	-	
Gate Input Resistance	R_{g}	f = 1 MHz, open drain		ı	3.2	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	60	
Pulsed Diode Forward Current	I _{SM}			=	-	160	- A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 30 A, V _{GS} = 0		-	-	4.1	V
Reverse Recovery Time	t _{rr}		., - 20 0, 13 - 00 1, 135 - 0		47	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}$, $I_F = I_S = 30 \text{A}$, $dI/dt = 1000 \text{A/}\mu\text{s}$, $V_R = 800 \text{V}$		-	220	-	μC
Reverse Recovery Current	I _{RRM}				60		Α

Notes

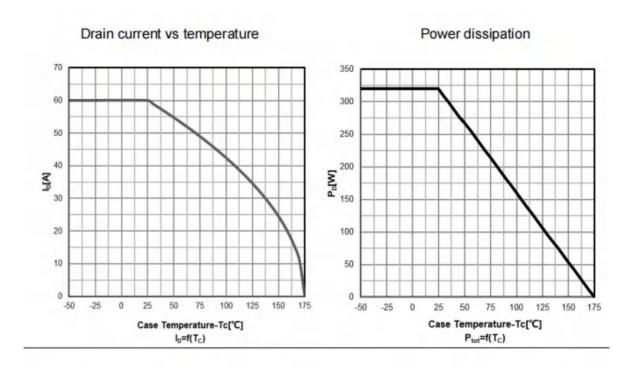
- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

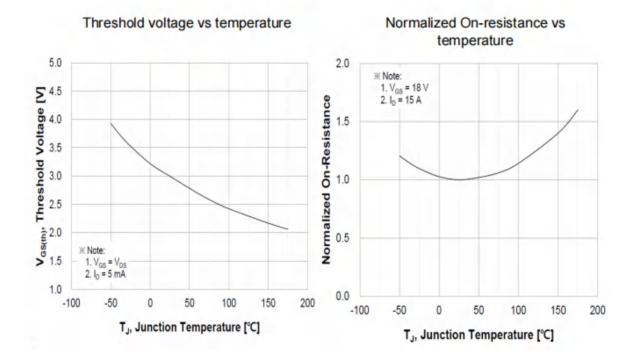




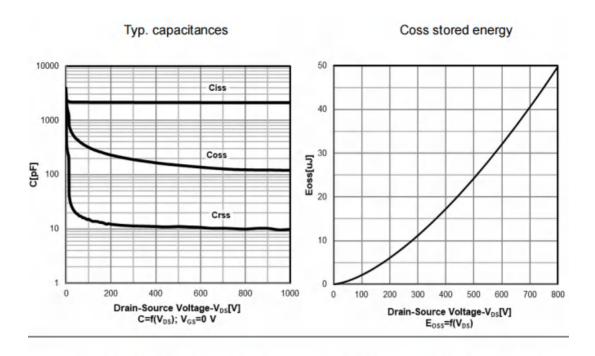


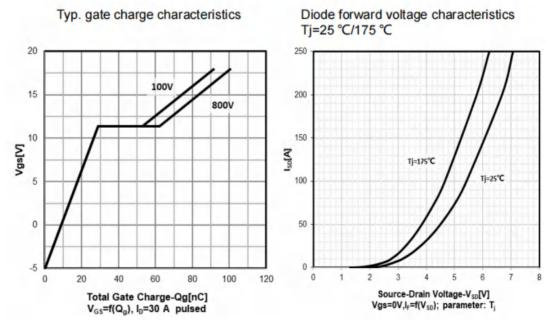








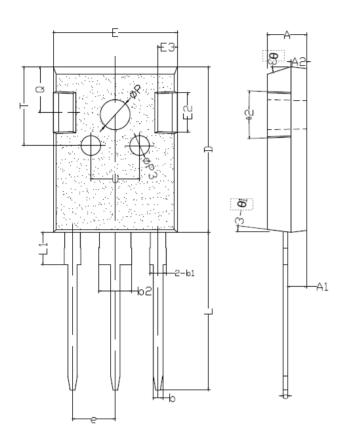


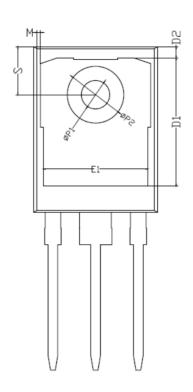


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TO-247 PACKAGE OUTLINE DIMENSIONS







SYMBOL -	mm				
	MIN	NOM	MAX		
*A	4.90	5.00	5.10		
*A1	2.31	2.41	2.51		
A2	1.90	2.00	2.10		
*b	1.15	1.20	1.25		
*b1	1.95	2.10	2.25		
*b2	2.95	3.10	3.25		
*c	0.55	0.60	0.65		
*D	20.90	21.00	21.10		
D1	16.35	16.55	16.75		
D2	1.05	1.20	1.35		



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